ememory

A Leading Logic NVM Company

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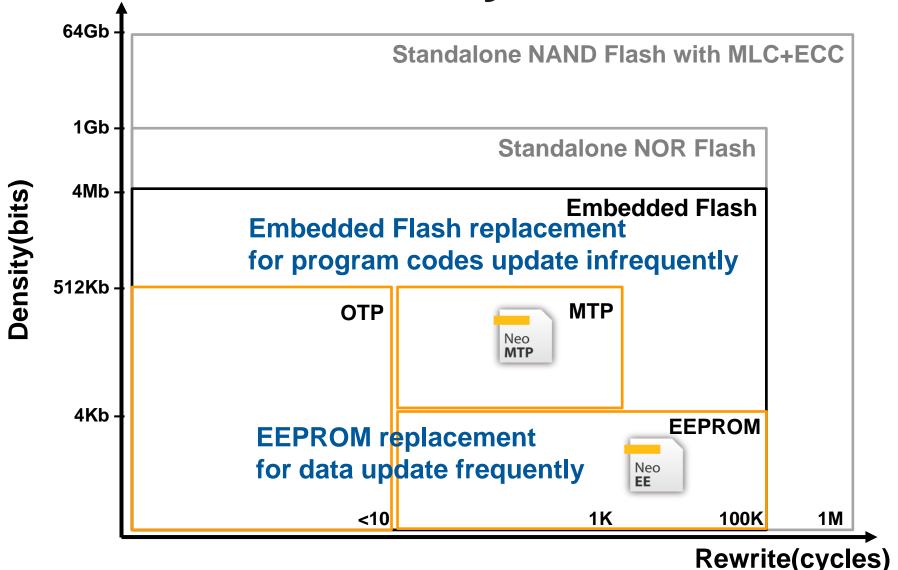
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Outline

- Business Model
- Review of Operations
- Growth Opportunity and Future Outlook
- Q & A

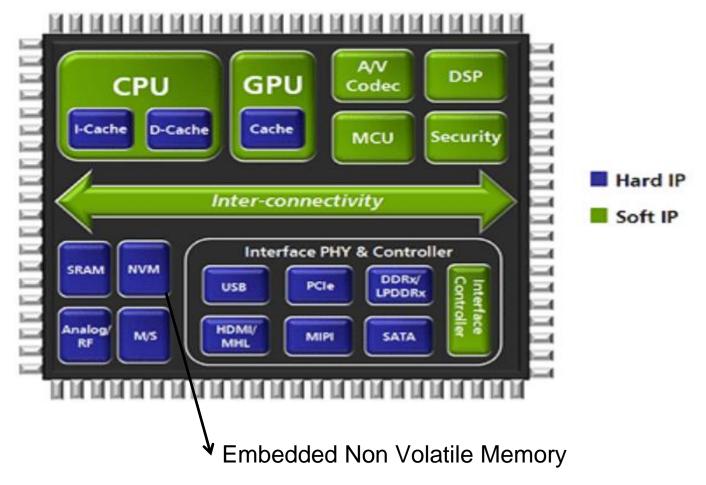


Nonvolatile Memory Classifications



Confidential

SOC Block Diagram



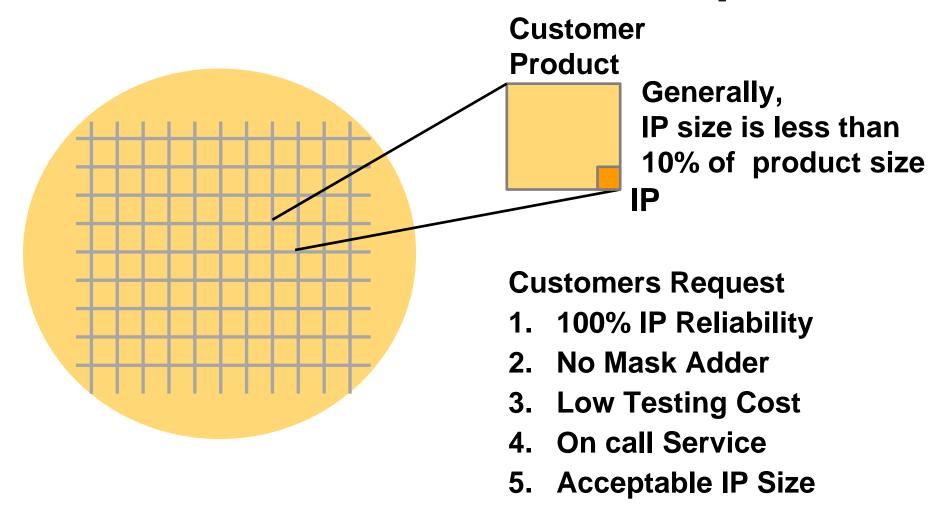
Source: tsmc

Embedded NVM Technologies

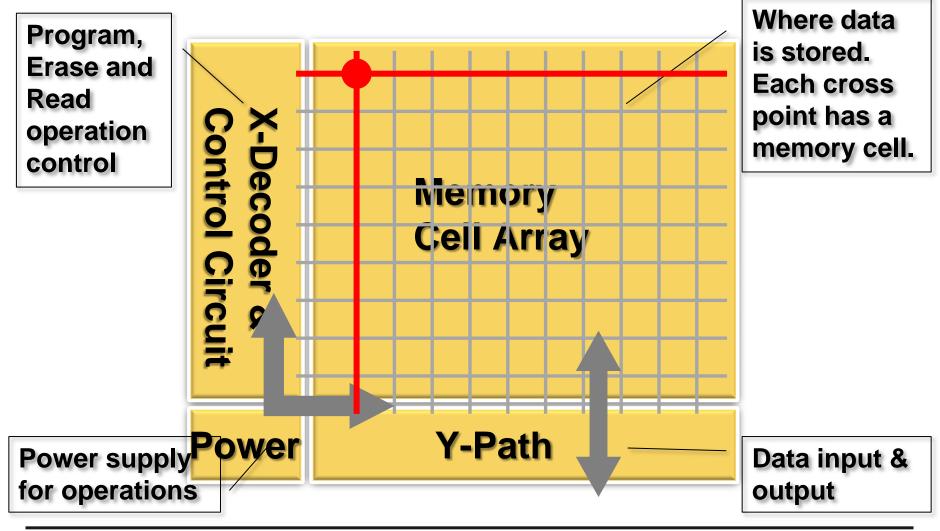
	ROM	eFuse (OTP)	Antifuse (OTP)	CMOS Floating Gate (OTP)	CMOS Floating Gate (MTP)	Embedded Flash
Cell Structure	Transistor	Poly Fuse	Antifuse	Floating Gate	Floating Gate	Floating Gate
Standard CMOS Compatible	Yes	Yes	Yes	Yes	Yes	No
Bitcell Area	<1	50	1	2	4	1
Endurance	No	No	< 10	< 10	10K-100K	100-1000K
Density	4Kb-1Mb	256bit-4Kb	16bit-1Mb	16Kb-1Mb	1Kb-2M	64Kb-4Mb
Security	Low	Low	High	High	High	High
Additional Steps	None	None	None	None	None	+10 Mask

- ROM not programmable, eFuse cannot scale beyond 16Kb, embedded flash expensive and cannot scale after 40 nm
- eMemory's IPs: OTP (antifuse, floating gate) and MTP (floating gate)

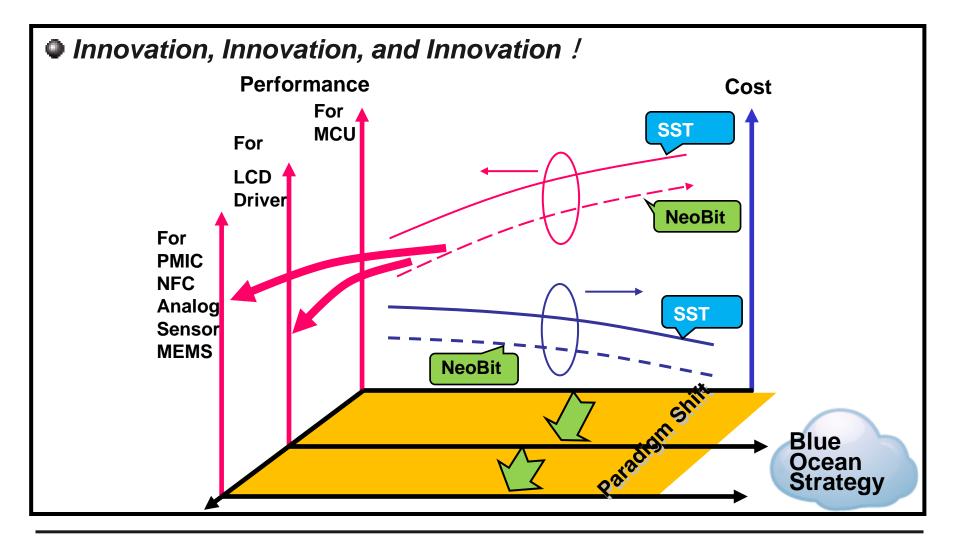
Considerations for IP Adoption



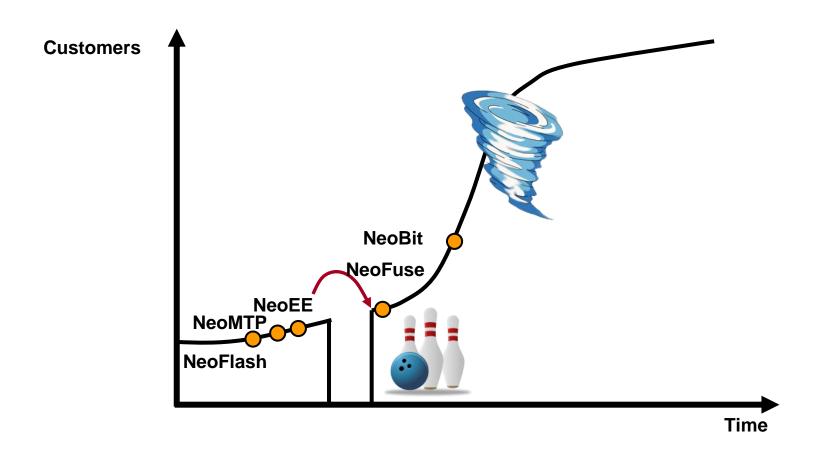
Inside Nonvolatile Memory IP



What We Have Done



Crossing the Chasm



Business Model

- Founded in 2000. First customer engaged in 2002. Achieved profitability in 2005 and IPO in 2011. The largest logic non-volatile memory IP company, 224 employees (157 R&D)*.
- Since its IPO, the company initiated no new fund raising or bank debt, and has distributed in excess of 100% of earnings in cash dividends.
- Growth Indices: 1) No. of on-going technology platforms
 - 2) No. of design licenses
 - 3) Royalty

Upfront Licensing Fee =Technology and Design License



Note*: As of Mar. 31st, 2016

mass production of customer wafers

Worldwide Customers



	Taiwan	China	Korea	Japan	North America	Europe	Others
Foundry	5	7	3	2	1	1	1
IDM	0	0	0	8	2	1	0
Fabless	251	409	59	47	191	107	42

Note*: As of Mar. 31st, 2016

Foundry



























































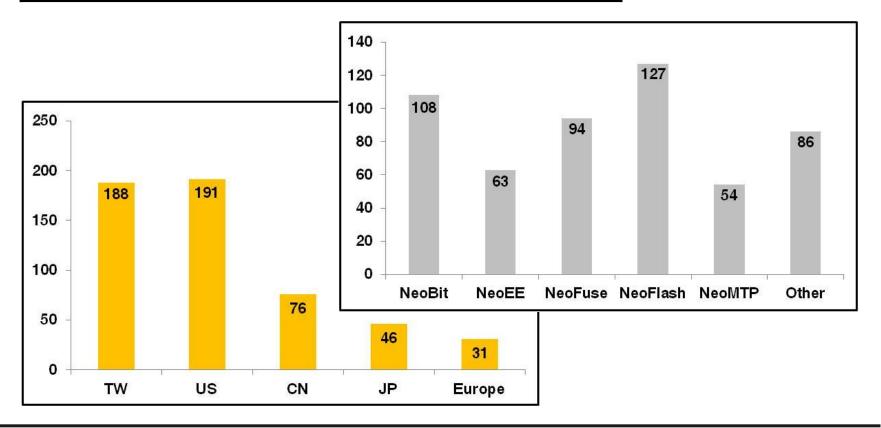






Patent Portfolio

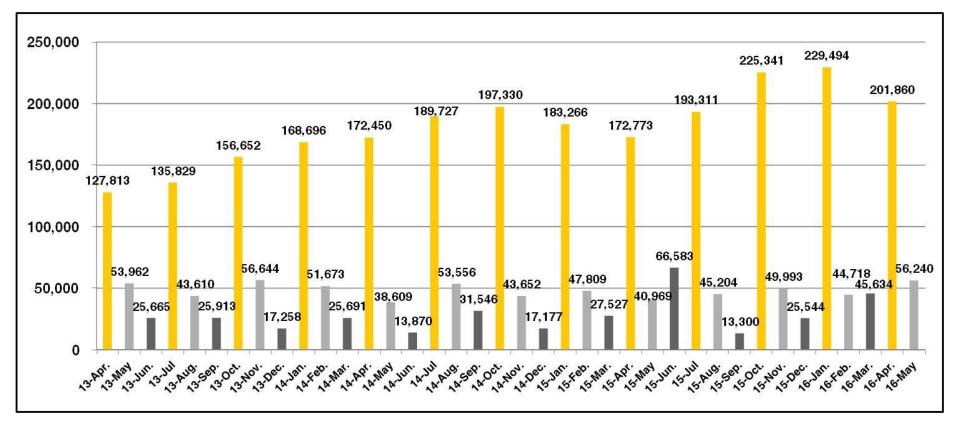
	Q4 15	Q1 16	Diff.
Pending	187	187	-
Issued	325	345	+20
Total	512	532	+20



Quarterly Revenue Pattern

• The quarterly royalty from most of foundries are collected at first month of each quarter and from some other foundries are collected at second month, and none at third month.

Unit: NTD Thousands



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Q1 Revenue Breakdown

Unit: NTD thousands

	Q1 2016	Q4 2015	QoQ	Q1 2015	YoY
Licensing	85,976	69,307	24.05%	64,056	34.22%
Royalty	233,870	231,571	0.99%	194,546	20.21%
Total	319,846	300,878	6.30%	258,602	23.68%

Unit: Number of contracts

		Q1 2016	Q4 2015	2015	2014
Technolog	y Licenses	13	11	28	21
Design	NRE	13	9	57	82
Licenses	Usage	69	104	349	363

Financial Income Statement

(Unit: NTD thousands)	Q1 2016	Q4 2015	% change	Q1 2015	% change
Revenue	319,846	300,878	6.3%	258,602	23.7%
Gross Margin	100%	100%	-	100%	-
Operating Expenses	177,088	156,216	13.4%	128,976	37.3%
Operating Margin	44.6%	48.1%	-3.5ppts	50.1%	-5.5ppts
Net Income	166,012	128,090	29.6%	114,423	45.1%
Net Margin	51.9%	42.6%	+9.3ppts	44.2%	+7.7ppts
EPS (Unit: NTD)	2.19	1.69	29.6%	1.51	45.0%
ROE	34.9%	28.4%	+6.5ppts	24.8%	+10.1ppts

Note 1: The employee stock option was recognized under compensation cost in Q1 2016; therefore, the operating expenses increased by NT\$2.281 million while the operating margin was down 0.71ppts.

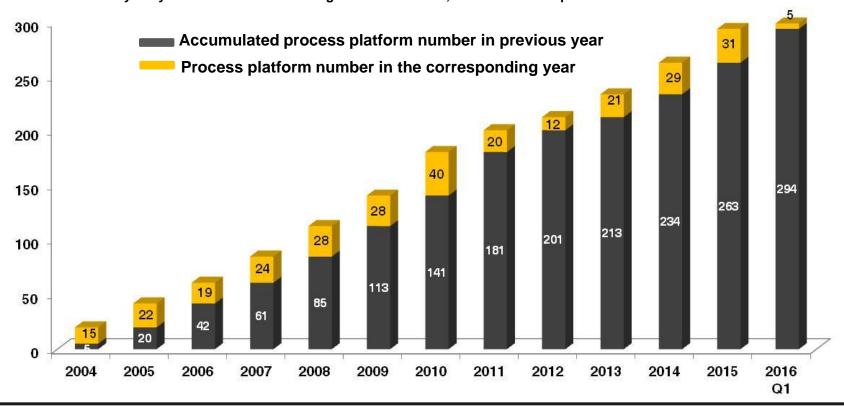
Note 2: Due to the disposal of financial assets in Q1 2016, the related cost from profit sharing to employees by non-operating income increased by NT\$7.389 million which affected the operating margin by 2.31ppts.

Technology License

Unit: Number of contract

Year	2013	2014	2015	Q1 2016
License number	19	21	28	13

Note: The terms (including number of process platforms and licensing fees) for each technology license are set contractually. Payments are made according to set milestones, and there are no particular seasonal factors involved.



Current Technology Development Platforms

- Total (As of Mar.) : 100
- 18 for NeoBit, 40 for NeoFuse, 23 for NeoEE, and
 19 for NeoMTP.

	10nm 14/16nm 28nm 40nm 55/65nm 80/90nm	14/16nm	28nm 40nm	40nm	55/65nm	80/90nm	0.11~	0.15~	>0.25	Total
				0.18um	um	Total				
NeoBit	•	-	-	-	-	1	6	12	ı	18
NeoFuse	1	3	9	5	8	4	7	3	-	40
NeoFlash	-	-	-	-	-	-	-	-	-	0
NeoEE	-	-	-	1	-	1	5	16	-	23
NeoMTP	-	-	-	-	2	2	5	10	-	19

Current Technology Development Platforms

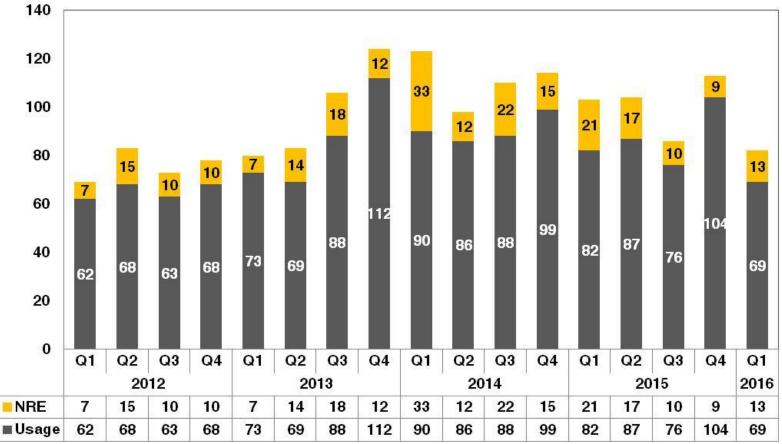
12" Fabs	Production	Development	NVM Type	Process Type
10nm	0	1	ОТР	FF
14/16nm	0	3	ОТР	FF+
28nm	5	9	ОТР	LP/HPM, HLP/HPM, LPS
40nm	2	6	OTP, MTP	HV-DDI, LP
55/65nm	11	10	OTP, MTP, Flash	LP, HV-DDI, HV-OLED, DRAM, CIS
80/90nm	5	7	OTP, MTP	HV-DDI, HV-OLED, LP
0.13/0.11um	6	4	OTP, Flash	HV-DDI, BCD, Generic
0.18um	1	0	ОТР	BCD

8" Fabs	Development	NVM Type	Process Type
0.13/0.11um	19	OTP, MTP, Flash	HV-DDI, BCD, LP, RF, CIS, LL
0.18/0.16/0.152um	41	OTP, MTP	Generic, LP, LL, MR, HV, Green, BCD
0.25um	0	OTP, MTP	BCD
0.35um	0	ОТР	UHV

*As of Mar. 31st, 2016

Quarterly Design Licensing (New Tape Out)

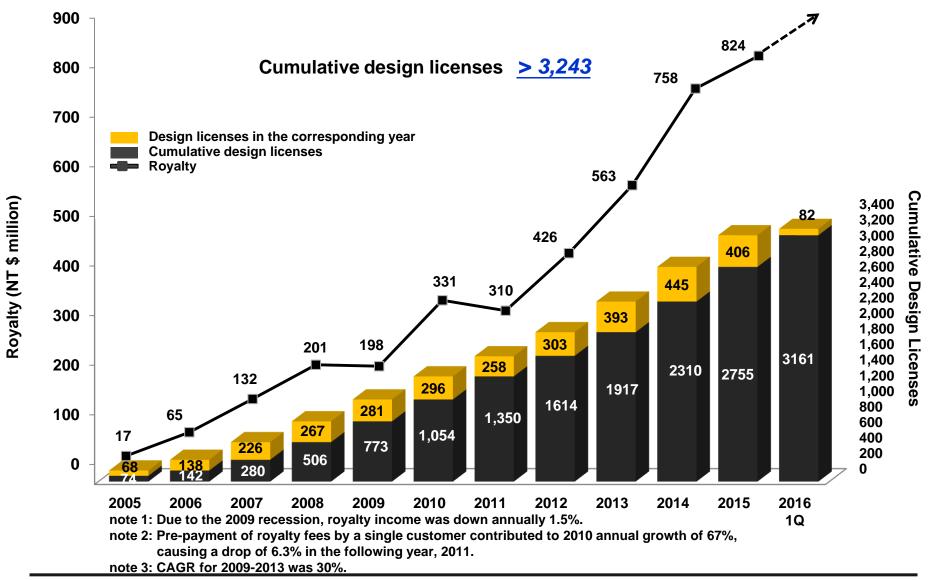
- Total 82 NTO as of in Q1 2016(406@2015,445@2014, 393@2013, 303@2012)



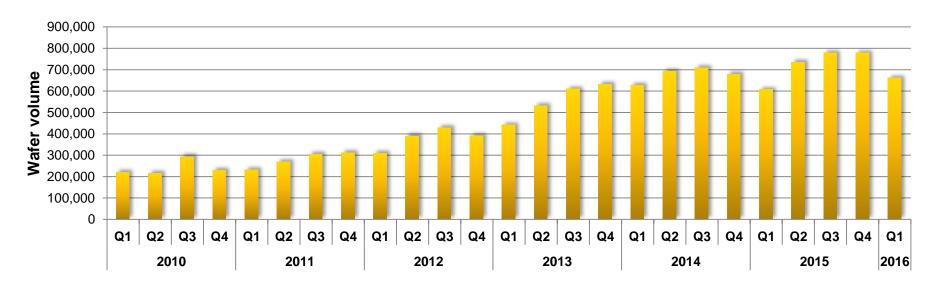
Note*: As the applications of MCU at several foundries have gradually entered mass production, and the business model of the main foundry partner which provides green process has shifted to — eMemroy licenses IP cell to the foundry for it to provide direct design service to customers — as the result, the new tape out number of MCU has been affected, drop 25 as it compare to Q1 2015, but the royalty coming from IP cell usage continues to roll in.

In summary, even the new tape out number of MCU is lower than before; the corresponding wafer output and royalty continue to grow.

Cumulative Licenses Drive Future Royalties



Wafer Production Volume



embedded eMemory IP in T Company (\$revenue); * % of Process node in T company total revenue in Q1 2016

	Process node	*% of T	Q1 16	Q4 15	2015	2014
8"	0.25/0.35	3%	40.91%	47.61%	33.49%	30.5%
	0.15/0.18	11%	13.41%	10.11%	8.73%	11.9%
	0.11/0.13	2%	27.53%	29.24%	29%	20.8%
12"	90nm	6%	20.04%	20.20%	19.85%	16.3%
	65nm	10%	2.91%	0.61%	0.55%	0%
	40/45nm	14%	0%	0%	0%	0%
	28nm	30%	0.46%	0.18%	0.05%	0%
	16/20nm	23%	0%	0%	0%	0%
8"		17%	20.33%	21.64%	16.64%	15.6%
12"		83%	1.97%	1.88%	1.87%	1.4%
Total		100%	5.09%	5.42%	4.76%	4.5%

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eMemory's NVM Technologies

- Logic NVM portfolio offers one-stop-shop solution.
 - Compatible to any process
- Competitive macro sizes

> Robust structure

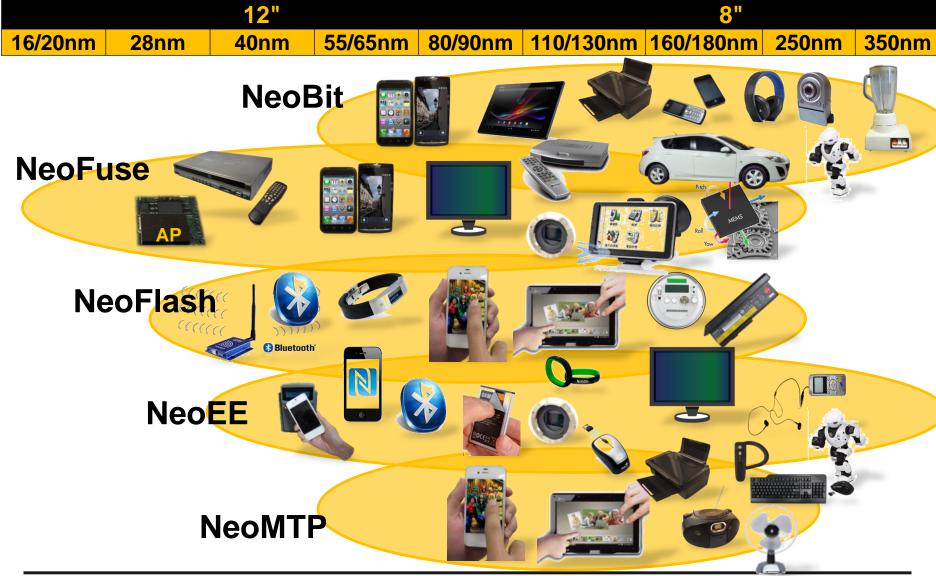
> Easy integration

> Low process cost

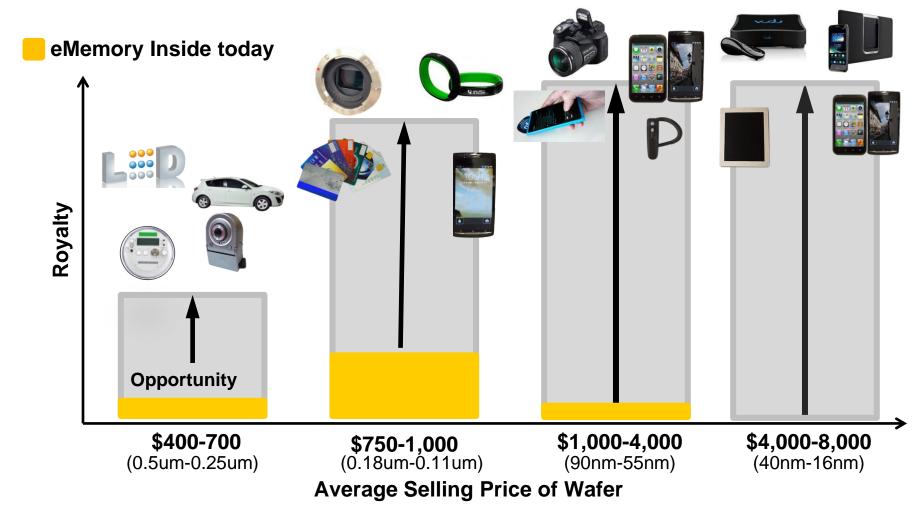
> Easy porting

eMemory's NVM	0	ГР	MTP			
Technology	NeoBit	NeoFuse	NeoFlash	NeoEE	NeoMTP	
Product Type	ОТР	ОТР	Flash	EEPROM	MTP	
Endurance (Cycles)	10	10	1K~10K	10K~100K	1K~10K	
Additional Mask Steps	0	0	2-3	0	0	
Technology	Floating gate	Anti-Fuse	SONOS	Floating gate	Floating gate	
Scalability	Simple	Simple	Simple	Simple	Simple	
Memory Density	HD < 512Kb GHD < 16Mb	< 4Mb	< 2Mb	< 4Kb	< 512Kb	

Applications by Technology

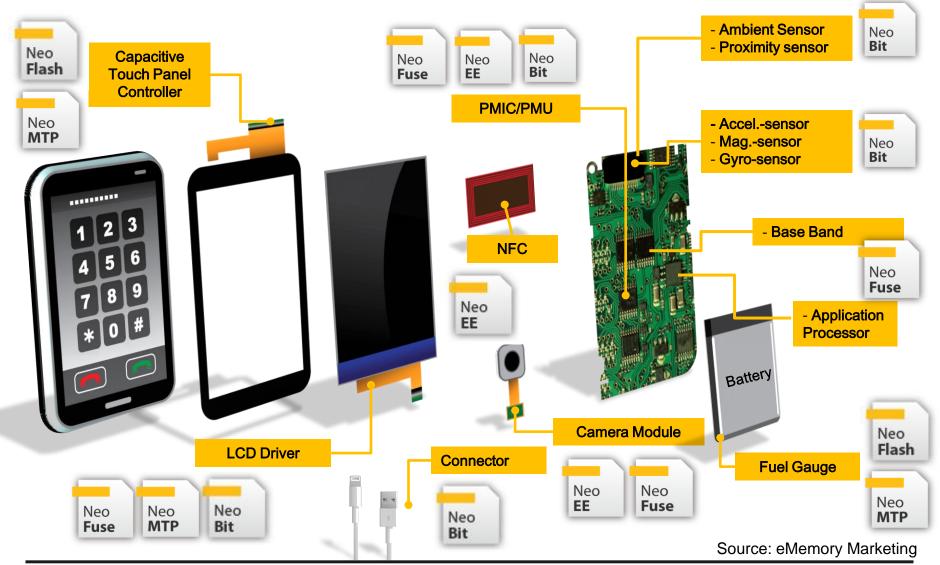


Opportunity at all Price Points



Note: 2.2 million 8" equivalent wafers with eMemory IP were shipped in 2013. (~5% of WW foundry shipment)

eMemory IP in Smart Phone



Benefits from Using eMemory IPs

Design-in for

- 1. Trimming
- 2. Parameter Setting
- 3. Code Storage
- 4. Identification Setting
- 5. Encryption

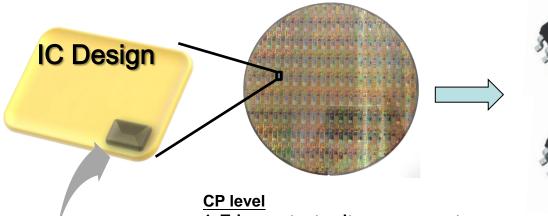
NVM IP

6. Function Selection

Package/FT level

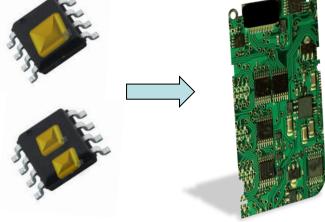
- 1. Trim: SPEC shift
- 2. Parameter Setting : cross chip optimization
- 3. Identification Setting: manufacturer resume
- 4. Function Selection : setting for target market

Package/FT System Assembling



CP Test

- 1. Trim : output voltage or current
- 2. Parameter Setting : default value
- 3. Code Storage : default F/W code



System Assembling

- 1. Parameter Setting: cross chip optimization
- 2. Code Storage: F/W code modification
- 3. Identification Setting: manufacturer resume
- 4. Encryption : Security algorithm or key storage

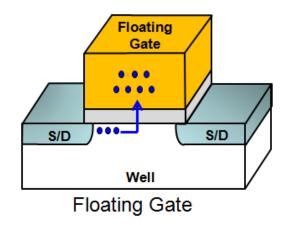
Invisibility for Security

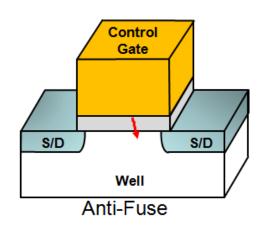
- Provide "Invisible Hardware Key" for invisible storage
- Prevent reverse-engineering to detect content of security key
- Protect firmware and hardware of ICs from pirating
- Extend & protect customer's business

eFuse Key: Data is easily observed

Invisible Hardware Key: Data is hard to be detected



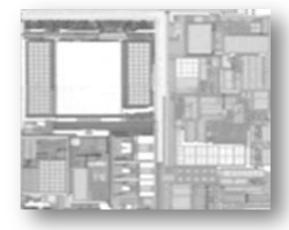






Security & Protection

Authorized Product

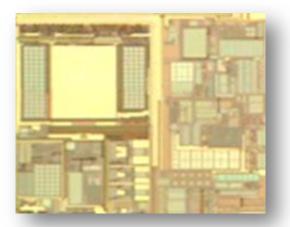


reverse copy

re-produce

without protection



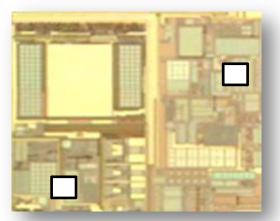




reverse copy

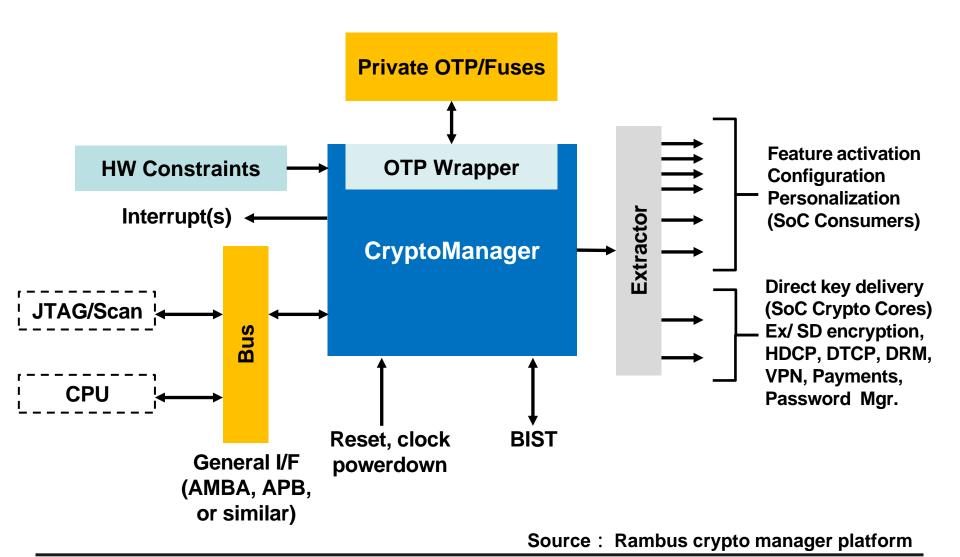
re-produce

with protection

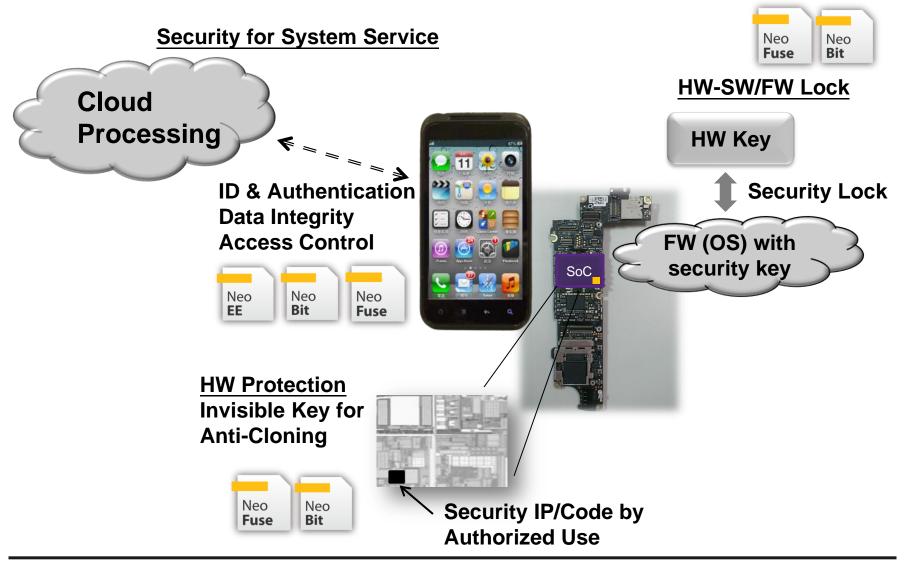


Can NOT Work w/o Security IP/Code

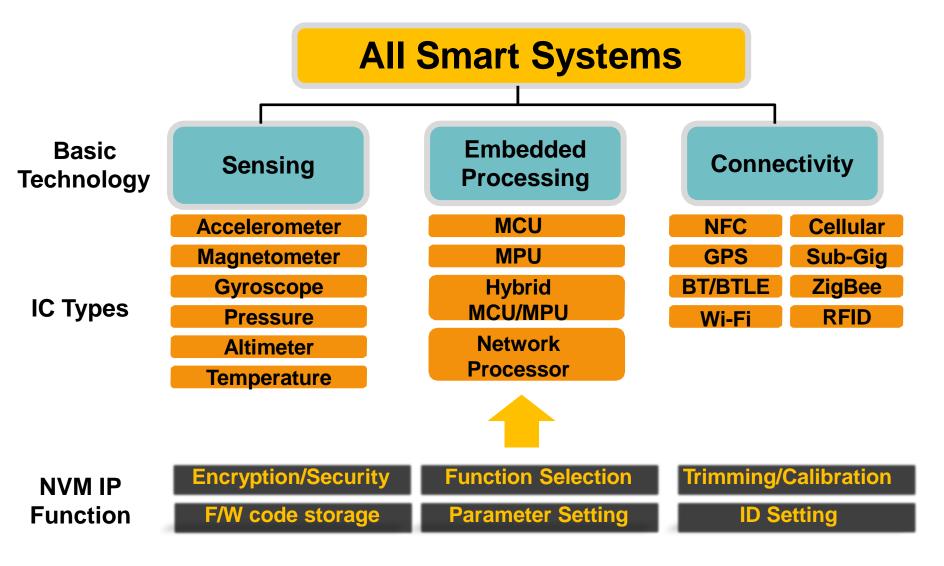
OTP for security storage



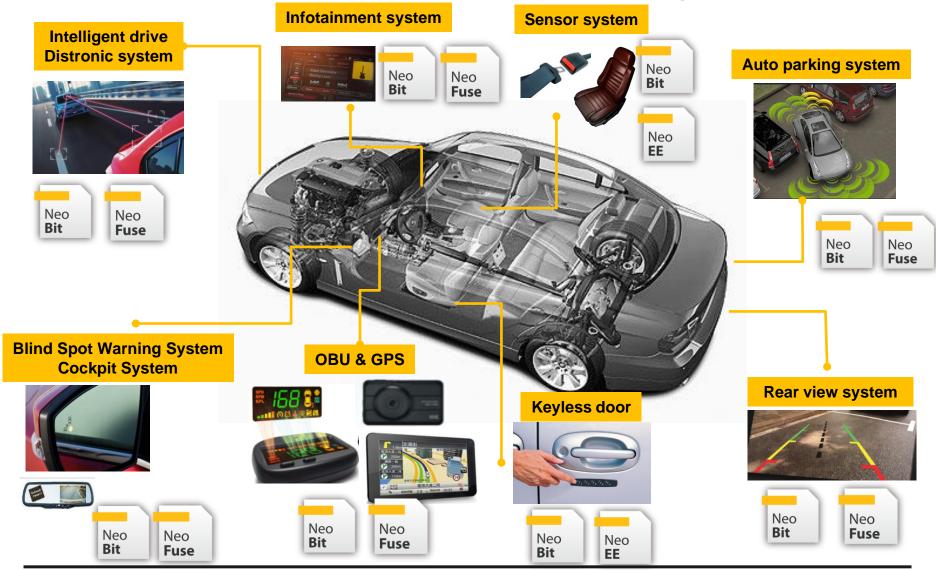
Security with eMemory IPs



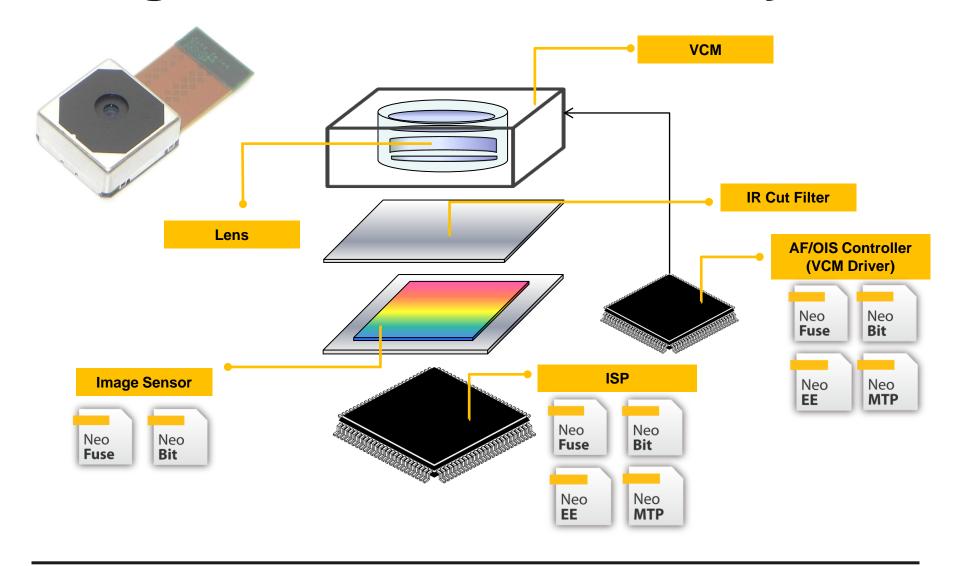
NVM IP Demand in IoT



Autotronics with eMemory IPs

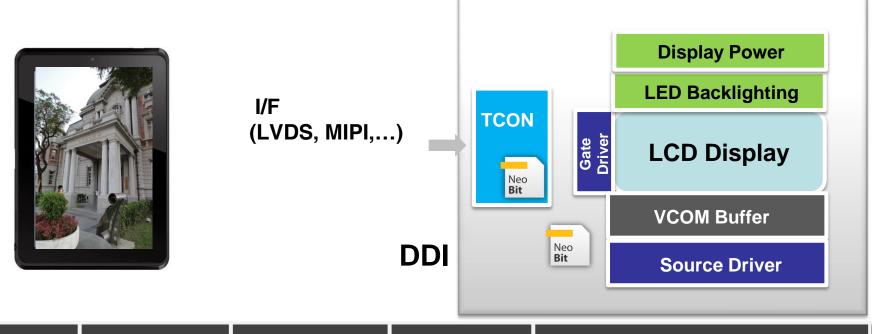


Imager Module with eMemory IPs



Advanced LCD Driver ICs

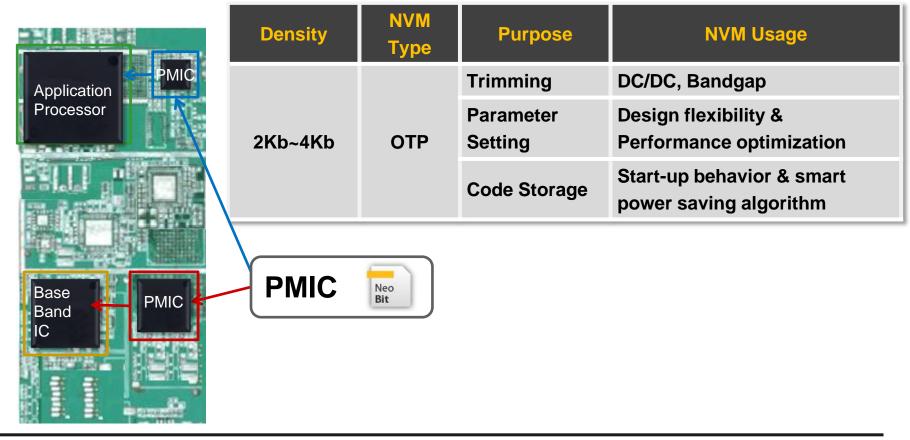
Process Technology: 0.11um HV/80nm HV/55nm HV



Density	Endurance	NVM Type	Purpose	NVM Usage
			Trimming	1. Accuracy enhancement
			Tillillillig	2. Mismatch cancellation
2K8~4K8	1 OTP		0	1. Gamma Correction Table
			Code Storage	2. Timing Control Pattern
				3. Color Engine Enhancement

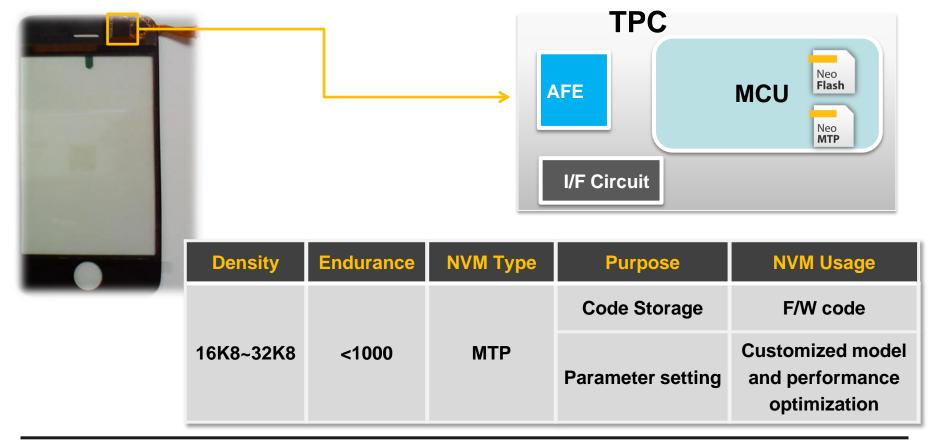
Power Management ICs for Baseband and Application Processor

Process Technology: Advanced 0.25um BCD/ 0.18um BCD/ 0.13um BCD Mature 0.18um/0.16um/0.152um Logic



Touch Panel Controller ICs

Process Technology: 0.16um HV/0.11um G

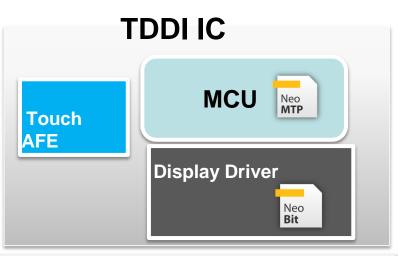


In-Cell Touch Panel Controllers ICs

Process Technology: 0.11um HV/80nm HV/55nm HV



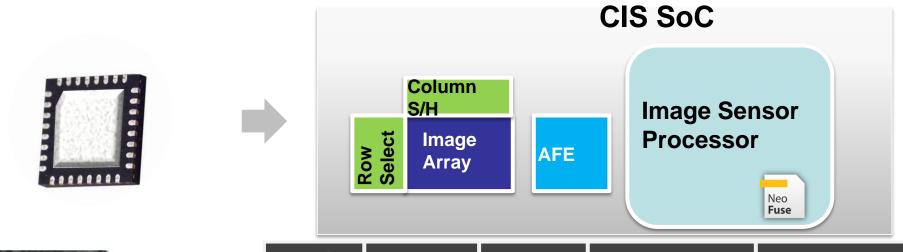


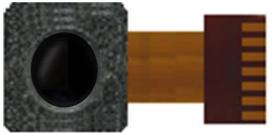


Density	Endurance	NVM Type	Purpose	NVM Usage
	4	OTP	Trimming	Accuracy
2K8~4K8		ОТР	Code Storage	Gamma Table
16K8~32K8	<1000	MTP	Code Storage	Touch F/W Code
			Parameter setting	Performance
			arameter setting	Optimization

CMOS Image Sensor

Process Technology: 0.11um CIS/90nm CIS/65nm CIS

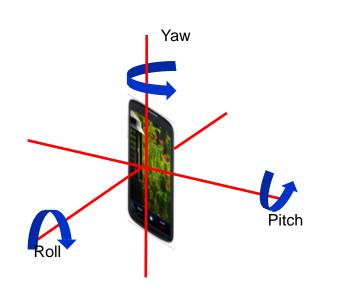


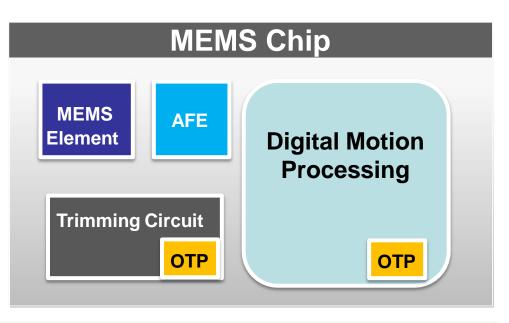


Density	Endurance	NVM Type	Purpose	NVM Usage
2Kb~4Kb	1	ОТР	Identification Setting	Product Code
			Parameter Setting	Start-up Initial Setting
32K8	1	OTP/ROM	Code Storage	Boot Load

MEMS

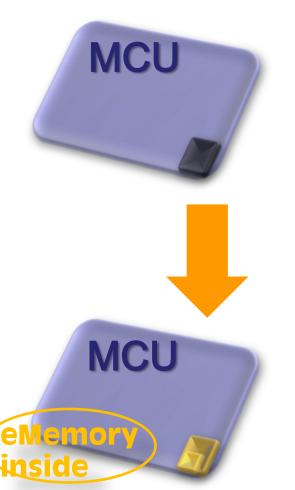
180/160/15x nm HV/Logic for MEMS Controller





Density	NVM Type	Purpose	NVM Usage
2Kb~4Kb		Trimming	Factory trimming
		Parameter Setting	Signal filtering
	Code Storage	Geometric computation	

Replacement of Embedded Flash for Competitiveness Improvement



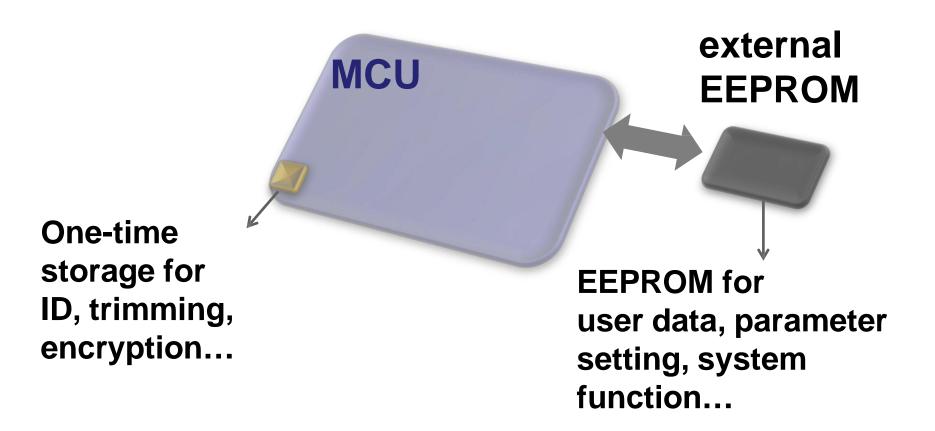
product design & manufacturing by embedded Flash Logic Process + 10 Masks

30% more cost reduction

wafer cost & testing time

product design & manufacturing by Embedded Logic NVM (OTP/MTP) Logic Process

MCU Applications with EEPROM



45

NeoBit + NeoEE

Hybrid NVM solution (NeoBit + NeoEE) with customized SPEC & optimized size



- One single IP by integration of NeoBit & NeoEE
- Help for system size reduction



Wafer Demand by IC Type

-			
IC Type	Equa to 8-inch wafer (K)		
AP	5740		
PMU	5255		
Base Band controller	2945		
Smart card controller	2683		
Fingerprint	2500		
CIS sensor	2215		
LCD driver (int with TCON)	1955		
Gauge IC	708		
TV controller	619		
Touch panel controller (C)	602		
Connectivity	463		
STB controller	348		
DC-DC/AC-DC	239		
Wifi controller	231		
Accelator sensor controller	166		
LED driver	140		
Light snesor	126		
Gyroscope sensor controller	120		
BT controller	107		
TAG IC	104		
MCU (8bits, LV/3.3V)	90		
MCU (8bits, pure 5V)	88		
ISP	82		
DVD controller	67		
P-Gamma	47		
NB CAM controller	38		
Pressure sensor controller	23		
Touch pad controller	16		
PC CAM controller	14		
Touch panel controller (R)	3		
TCON (w/o driver)	3		
Speech controller	0		

2015 Q3 updated

Outlook for Q1 and Beyond

- License fees expected to grow due to the successful development of NeoFuse in advanced nodes, and MTP technology.
- PMIC continually expands to applications for wireless charger and fast charger related products.
- 55nm TDDI continues volume production. 40nm OLED DDI is under development at several major foundries.
- 28nm Set-top Box processor starts volume production.
 More customers tape out new products in Q2 of 2016.
- Fingerprint and CIS customers start volume production in Q2 of 2016.

Outlook for Q1 and Beyond

- The qualification of 16nm FF+ was completed at end of March 2016 and 16nm FFC qualification started in Q2 of 2016.
- 10nm FF IP taped out in Q2.
- NeoPUF, new technology for security application is under development.
- Continuously tape outs on automotive applications.

Key Growth Drivers

Growth in application per mobile devices

More chip applications per smartphone/tablet product.

Growth into more markets

- From consumer electronics and mobile devices to wearable devices.
- Adding new NVM product lines further enable more product applications.

Growth in advanced technology

 Higher royalty per wafer is contributed from more advanced technology nodes.

Great IoT era

• Embedded Logic NVM will be a must.

Q & A

ememory

Embedded Wisely, Embedded Widely